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#### NCE N-Channel Enhancement Mode Power MOSFET

#### Description

The NCE0160G uses advanced trench technology and design to provide excellent  $R_{\rm DS(ON)}$  with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

#### **General Features**

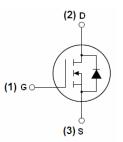
- $V_{DS} = 100V, I_D = 60A$  $R_{DS(ON)} < 16m\Omega @ V_{GS} = 12.6V$
- Special designed for convertors and power controls
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

#### Application

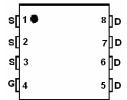
- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



#### Schematic diagram



#### Marking and pin assignment



DFN5X6-8L top view

#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0160G	NCE0160G	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	60	А
Drain Current-Continuous(T <sub>C</sub> =70°ℂ)	I <sub>D</sub> (70°C)	50	Α
Pulsed Drain Current	I <sub>DM</sub>	80	Α
Maximum Power Dissipation	P <sub>D</sub>	105	W
Derating factor		0.70	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	550	mJ
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 175	$^{\circ}$ C



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# NCE0160G

#### Thermal Characteristic

Thermal Resistance, Junction-to- Case (Note 2)	R <sub>θJc</sub> 1.43	°C/W
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## Electrical Characteristics (T<sub>C</sub>=25°Cunless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	2.5	3.7	4.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =30A	-	12.6	16	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =15V,I <sub>D</sub> =10A	-	30	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ -50\/\/ -0\/	-	2850	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =50V, $V_{GS}$ =0V, F=1.0MHz	-	220	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UNITZ	-	90	-	PF
Switching Characteristics (Note 4)	·		•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	17	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =30V, $I_D$ =5A, $R_L$ =10 $\Omega$	-	10	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =1 $\Omega$	-	26	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Qg	\/ _F0\/   _40A	-	47	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=50V,I_{D}=10A,$ $V_{GS}=10V$	-	13		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> -10V	-	12.5	-	nC
Drain-Source Diode Characteristics	<u>.</u>		•			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =4A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	60	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 10A	-	-	60	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>		-	200	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

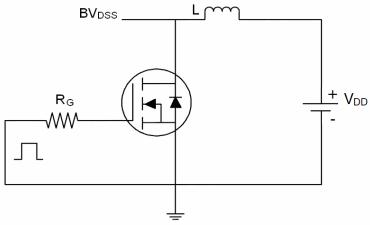
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu s$ , Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25  $^{\circ}\text{C}$  ,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$

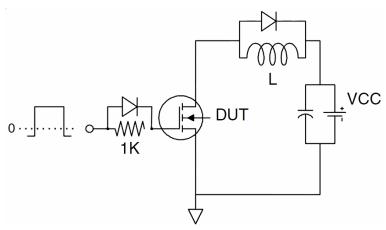
# **NCE0160G**

### **Test Circuit**

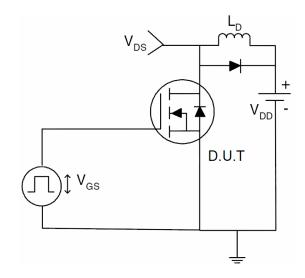
## 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit



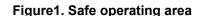
#### 3) Switch Time Test Circuit



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### Typical Electrical and Thermal Characteristics (Curves)



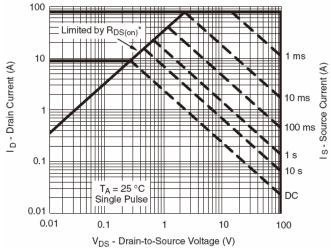
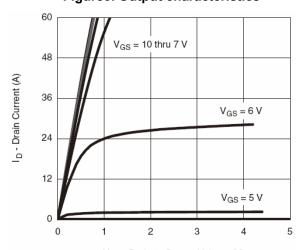


Figure 3. Output characteristics



V<sub>DS</sub> - Drain-to-Source Voltage (V) Figure5. Static drain-source on resistance

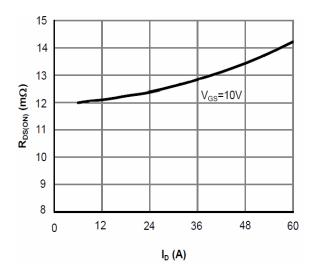


Figure 2. Source-Drain Diode Forward Voltage

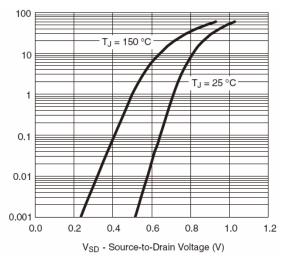


Figure 4. Transfer characteristics

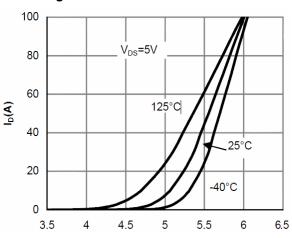
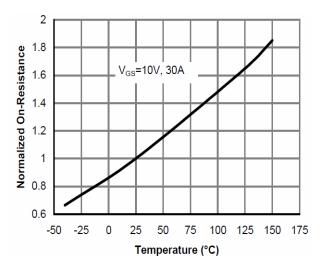


Figure 6. R<sub>DS(ON)</sub> vs Junction Temperature



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## **NCE0160G**

Figure 7. BV<sub>DSS</sub> vs Junction Temperature

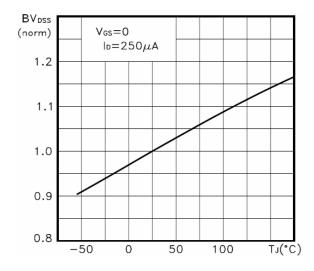


Figure 9. Gate charge waveforms

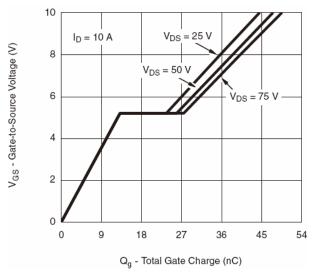


Figure 8. V<sub>GS(th)</sub> vs Junction Temperature

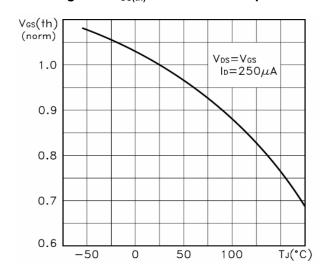


Figure 10. Capacitance

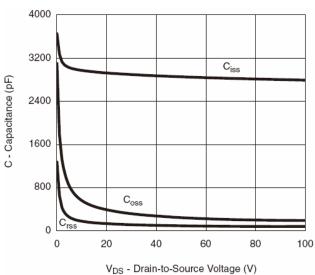
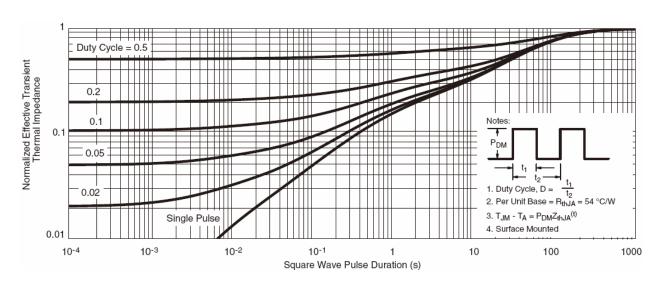


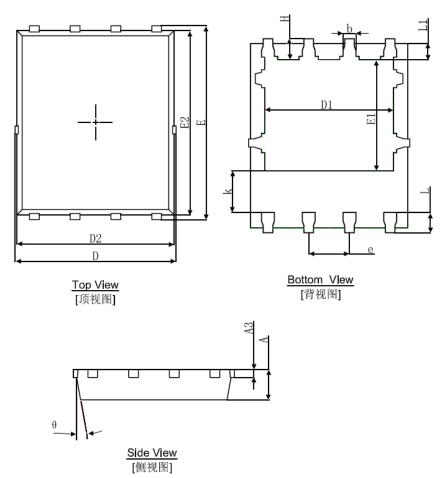
Figure 11. Normalized Maximum Transient Thermal Impedance



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# NCE0160G

## **DFN5X6-8L Package Information**



Comple et	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	0.900	1.000	0.035	0.039	
A3	0.254REF.		0.010	REF.	
D	4.944	5.096	0.195	0.201	
Е	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
К	1.190	1.390	0.047	0.055	
b	0.035	0.450	0.014	0.018	
е	1.270(TYP.)		0.050(TYP.)		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	



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